XP05601 (XP5601)

Silicon PNP epitaxial planer transistor (Tr1) Silicon NPN epitaxial planer transistor (Tr2)

For general amplification

Features

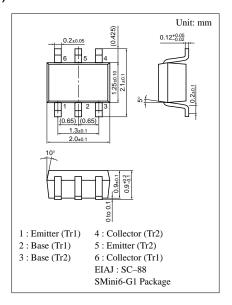
- Two elements incorporated into one package.
- Reduction of the mounting area and assembly cost by one half.

Basic Part Number of Element

• 2SB0709A(2SB709A) + 2SD0601A(2SD601A)

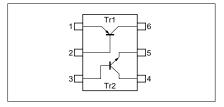
Absolute Maximum Ratings (Ta=25°C)

| ı | Parameter | Symbol | Ratings | Unit |
|---------|------------------------------|------------------|-------------|------|
| Trl | Collector to base voltage | V_{CBO} | -60 | V |
| | Collector to emitter voltage | V _{CEO} | -50 | V |
| | Emitter to base voltage | $V_{\rm EBO}$ | -7 | V |
| | Collector current | I_{C} | -100 | mA |
| | Peak collector current | I_{CP} | -200 | mA |
| Tr2 | Collector to base voltage | V _{CBO} | 60 | V |
| | Collector to emitter voltage | V _{CEO} | 50 | V |
| | Emitter to base voltage | $V_{\rm EBO}$ | 7 | V |
| | Collector current | I_{C} | 100 | mA |
| | Peak collector current | I_{CP} | 200 | mA |
| Overall | Total power dissipation | P_{T} | 150 | mW |
| | Junction temperature | T_{j} | 150 | °C |
| | Storage temperature | T_{stg} | -55 to +150 | °C |



Marking Symbol: 4N

Internal Connection



■ Electrical Characteristics (Ta=25°C)

• Tr1

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|---|----------------------|---|----------------|-------|-------|------|
| Collector to base voltage | V _{CBO} | $I_{\rm C} = -10\mu A, I_{\rm E} = 0$ | -60 | | | V |
| Collector to emitter voltage | V _{CEO} | $I_{C} = -2mA, I_{B} = 0$ | -50 | | | V |
| Emitter to base voltage | V _{EBO} | $I_{\rm E} = -10 \mu A, I_{\rm C} = 0$ | - 7 | | | V |
| Collector cutoff current | I_{CBO} | $V_{CB} = -20V, I_E = 0$ | | | - 0.1 | μΑ |
| Collector cutoff current | I_{CEO} | $V_{CE} = -10V, I_B = 0$ | | | -100 | μΑ |
| Forward current transfer ratio | h _{FE} | $V_{CE} = -10V, I_{C} = -2mA$ | 160 | | 460 | |
| Collector to emitter saturation voltage | V _{CE(sat)} | $I_{\rm C} = -100 \text{mA}, \ I_{\rm B} = -10 \text{mA}$ | | - 0.3 | - 0.5 | V |
| Transition frequency | f_T | $V_{CB} = -10V$, $I_E = 1mA$, $f = 200MHz$ | | 80 | | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = -10V$, $I_E = 0$, $f = 1MHz$ | | 2.7 | | pF |

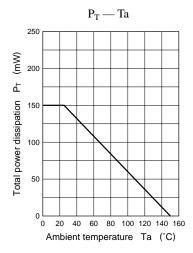
• Tr2

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|---|----------------------|---|-----|-----|-----|------|
| Collector to base voltage | V _{CBO} | $I_C = 10\mu A, I_E = 0$ | 60 | | | V |
| Collector to emitter voltage | V _{CEO} | $I_C = 2mA$, $I_B = 0$ | 50 | | | V |
| Emitter to base voltage | V _{EBO} | $I_{\rm E} = 10 \mu A, I_{\rm C} = 0$ | 7 | | | V |
| Collector cutoff current | I_{CBO} | $V_{CB} = 20V, I_E = 0$ | | | 0.1 | μА |
| Collector cutoff current | I_{CEO} | $V_{CE} = 10V, I_B = 0$ | | | 100 | μΑ |
| Forward current transfer ratio | h_{FE} | $V_{CE} = 10V$, $I_C = 2mA$ | 160 | | 460 | |
| Collector to emitter saturation voltage | V _{CE(sat)} | $I_{\rm C} = 100 {\rm mA}, I_{\rm B} = 10 {\rm mA}$ | | 0.1 | 0.3 | V |
| Transition frequency | f_T | $V_{CB} = 10V, I_E = -2mA, f = 200MHz$ | | 150 | | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = 10V, I_E = 0, f = 1MHz$ | | 3.5 | | pF |

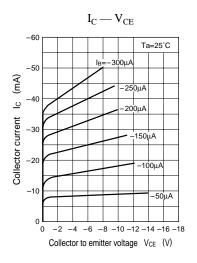
^{*1} Ratio between 2 elements

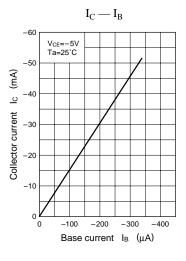
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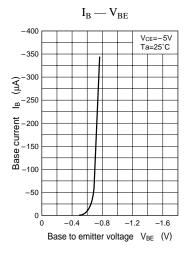
Common characteristics chart

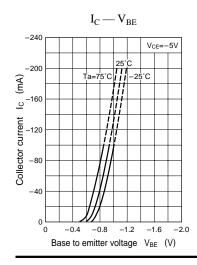


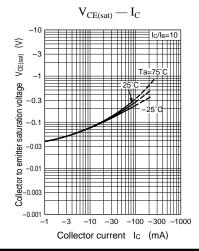
Characteristics charts of Tr1

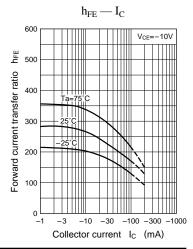


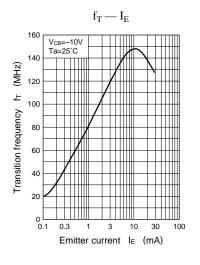


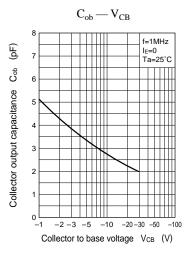


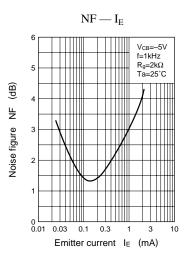


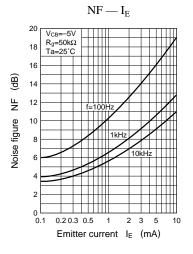


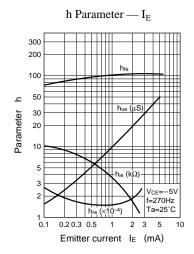


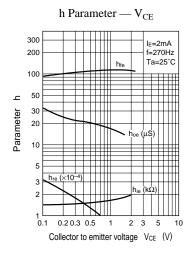




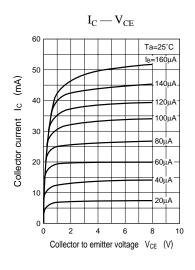


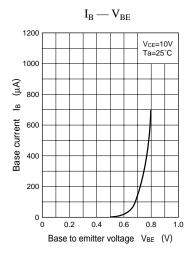


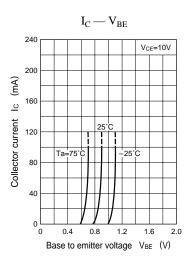




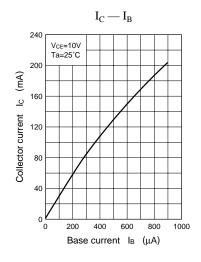
Characteristics charts of Tr2

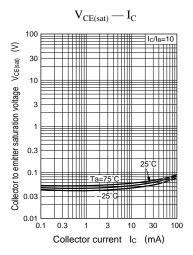


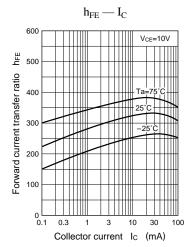


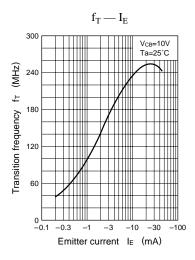


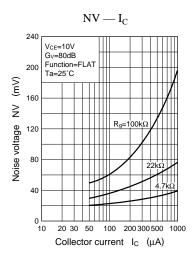
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